

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5203346

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KARTHIK THIRU	10/17/2018
RAVI NATARAJAN	10/16/2018
PRATEEK TRIPATHI	10/16/2018
SOUMYA RANJAN DAS	10/16/2018
ANKIT JAIN	10/16/2018
KISHAN RAO RAMESH YARADI	10/23/2018
VIJAYALAKSHMI MOHANDOSS	10/17/2018
AVINASH BHASKAR	10/18/2018
KARTIK CHANDRA	10/17/2018
PAVITHRA THIAGARAJAN	10/17/2018
YATENDRA KUMAR TIWARI	10/17/2018

RECEIVING PARTY DATA

Name:	SAP SE
Street Address:	DIETMAR-HOPP-ALLEE 16
City:	WALLDORF
State/Country:	GERMANY
Postal Code:	D-69190

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16169083

CORRESPONDENCE DATA

Fax Number: (203)972-7627

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 203-972-0006

Email: venuto@bmtpatent.com, colabella@bmtpatent.com

Correspondent Name: BUCKLEY, MASCHOFF & TALWALKAR LLC

Address Line 1: 50 LOCUST AVENUE

Address Line 4: NEW CANAAN, CONNECTICUT 06840

ATTORNEY DOCKET NUMBER:	180857US01 (S21,280)
NAME OF SUBMITTER:	NICHOLAS M. STABLER
SIGNATURE:	/NMS/
DATE SIGNED:	10/24/2018

Total Attachments: 11

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Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Karthik Thiru**,
hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

Digital Compliance Platform

which is found in the:

US patent application filed on: **October 24, 2018**

under Application No. **16/169,083**

I authorize and request the attorneys of record or the attorney filing the application to insert into this assignment the filing date and serial number of the application when known. This assignment includes the foregoing patent application or patent, as well as continuations and divisionals of said application, all legal equivalents in any country, and all patents issuing from such legal equivalents; all patents, utility models, and design registrations granted by any jurisdiction for any of said inventions and improvements; and the right to claim priority based on the filing date of the foregoing patent application or patent under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes. I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements. I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into that would conflict with this assignment. I hereby state and agree that no assignment, sale, agreement, or encumbrance has been or will be made or entered into that would conflict with this assignment. I further agree for myself and my heirs, legal representatives, and assigns to provide to the Assignee promptly upon its request and at its expense all pertinent facts and documents relating to any of said inventions and improvements or said patents and legal equivalents as may be known and accessible to me and to testify as to the same in any interference, litigation, or proceeding relating thereto; and I agree promptly to perform such lawful acts and to sign such further applications, assignments, statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Inventor's Signature:

DocuSigned by:
Karthik Thiru

10/17/2018

Karthik Thiru

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Ravi Natarajan**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

Digital Compliance Platform

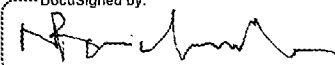
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Inventor's Signature:

DocuSigned by:

89C1011A6D61418...
Ravi Natarajan

10/16/2018

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Prateek Tripathi**,

hereby assign to

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and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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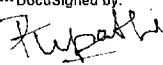
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Inventor's Signature:

DocuSigned by:


10/16/2018

Prateek Tripathi

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Soumya Ranjan Das,**

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Soumya Ranjan Das
30114A501F644A1...
Soumya Ranjan Das

10/16/2018

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **ANKIT JAIN**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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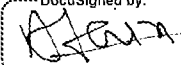
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Inventor's Signature:

DocuSigned by:

EFFF43289C96435...

ANKIT JAIN

10/16/2018

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Kishan Rao Ramesh Yaradi**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Kishan Rao Ramesh Yaradi 10/23/2018
EE506FC1F2123CD
Kishan Rao Ramesh Yaradi

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Vijayalakshmi Mohandoss**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Vijayalakshmi Mohandoss

Vijayalakshmi Mohandoss

10/17/2018

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Avinash Bhaskar**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Avinash Bhaskar

10/18/2018

-----B742EB15A46E48A...
Avinash Bhaskar

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Kartik Chandra**,

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:
Kartik Chandra
7A2981AADS648E...
Kartik Chandra

10/17/2018

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Pavithra Thiagarajan,**

hereby assign to

SAP SE, a corporation of Europe having a place of business at Dietmar-Hopp-Allee 16, 69190 Walldorf, Germany

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Inventor's Signature:

DocuSigned by:
Pavithra Thiagarajan
4745F5AC74BD8B5...

10/17/2018

Pavithra Thiagarajan

Attorney Dkt. No. S21.280P / 180857US01

ASSIGNMENT

For valuable consideration, I, **Yatendra Kumar Tiwari**,

hereby assign to

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and its successors, and assigns (collectively, the ASSIGNEE) my entire right, title and interest throughout the world in the inventions and improvements in a patent document entitled:

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Inventor's Signature:

DocuSigned by:



10/17/2018

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Yatendra Kumar Tiwari